Excellent Integrated System Limited

Stocking Distributor

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Vishay/Siliconix
SI4493DY-T1-E3

For any questions, you can email us directly:
sales@integrated-circuit.com

P-Channel 2.5-V (G-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
- 20	0.00775 at V_{GS} = - 4.5 V	- 14
	0.01225 at V_{GS} = - 2.5 V	- 11

FEATURES

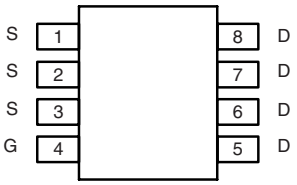
- **Halogen-free According to IEC 61249-2-21 Definition**
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

Pb-free
RoHS COMPLIANT
HALOGEN FREE Available

APPLICATIONS

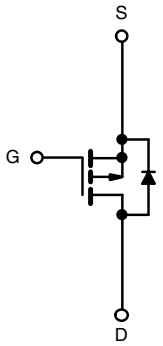
- Load Switch

SO-8



Top View

Ordering Information: Si4493DY-T1-E3 (Lead (Pb)-free)
Si4493DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted					
Parameter		**Symbol**	**10 s**	**Steady State**	**Unit**
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 12		
Continuous Drain Current (T_J = 150 °C)[a]	T_A = 25 °C	I_D	- 14	- 10	A
	T_A = 70 °C		- 11	- 8	
Pulsed Drain Current		I_{DM}	- 50		
Continuous Source Current (Diode Conduction)[a]		I_S	- 2.7	- 1.36	
Maximum Power Dissipation[a]	T_A = 25 °C	P_D	3.0	1.5	W
	T_A = 70 °C		1.9	0.95	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[a]	t ≤ 10 s	R_{thJA}	33	42	°C/W
	Steady State		70	84	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	16	21	

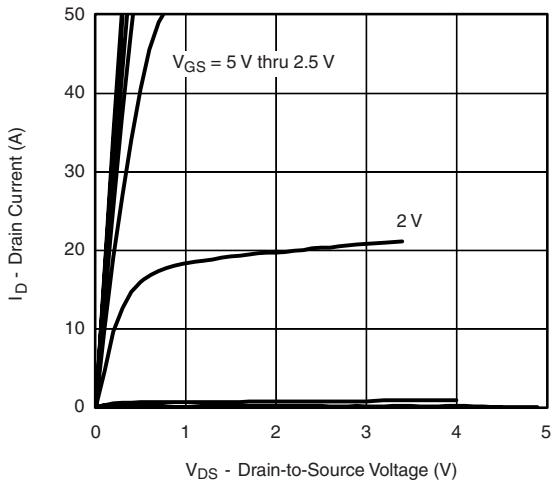
Notes:
a. Surface Mounted on 1" x 1" FR4 board.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.6		- 1.4	V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 12 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 20 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 20 V, V_{GS} = 0 V, T_J = 70 °C			- 10	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = - 5 V, V_{GS} = - 4.5 V	- 30			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 14 A		0.0065	0.00775	Ω
		V_{GS} = - 2.5 V, I_D = - 11 A		0.010	0.01225	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 10 V, I_D = - 14 A		60		S
Diode Forward Voltage[a]	V_{SD}	I_S = - 2.7 A, V_{GS} = 0 V		- 0.68	- 1.1	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 14 A		65	110	nC
Gate-Source Charge	Q_{gs}			14.5		
Gate-Drain Charge	Q_{gd}			21		
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 10 V, R_L = 10 Ω $I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		110	165	ns
Rise Time	t_r			150	225	
Turn-Off Delay Time	$t_{d(off)}$			220	330	
Fall Time	t_f			140	210	
Gate Resistance	R_g			3.8		Ω
Source-Drain Reverse Recovery Time	t_{rr}	I_F = - 2.7 A, dI/dt = 100 A/µs		85	130	ns

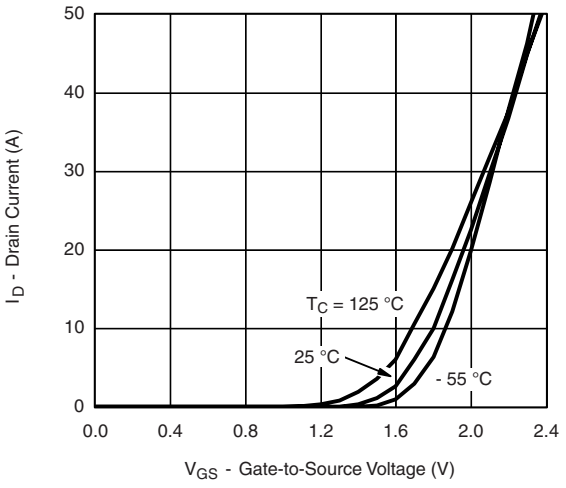
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

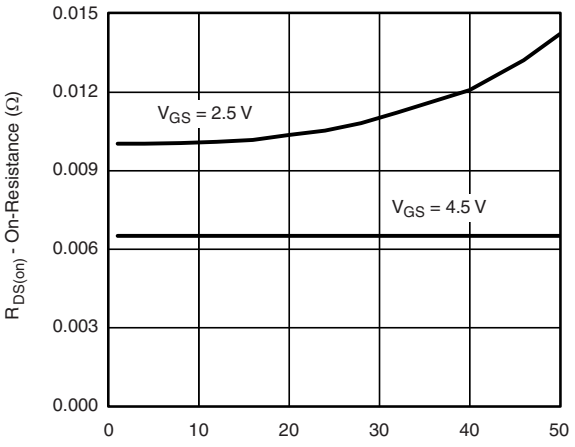


Output Characteristics

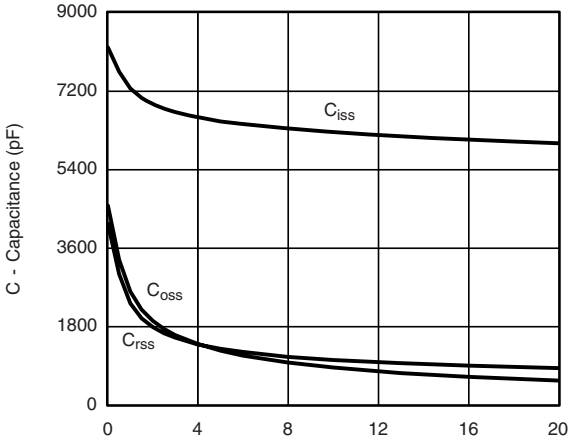


Transfer Characteristics

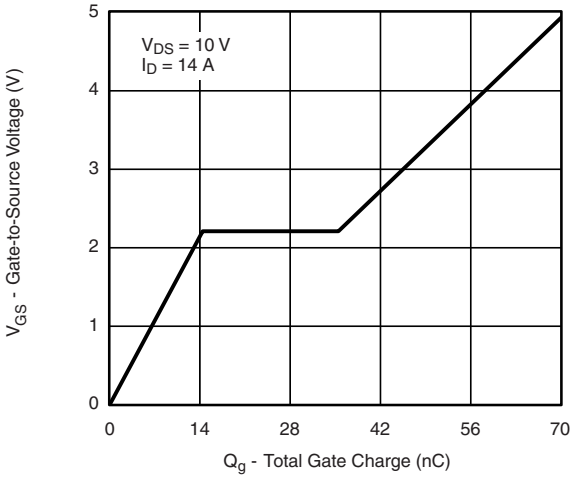
TYPICAL CHARACTERISTICS 25 °C unless noted



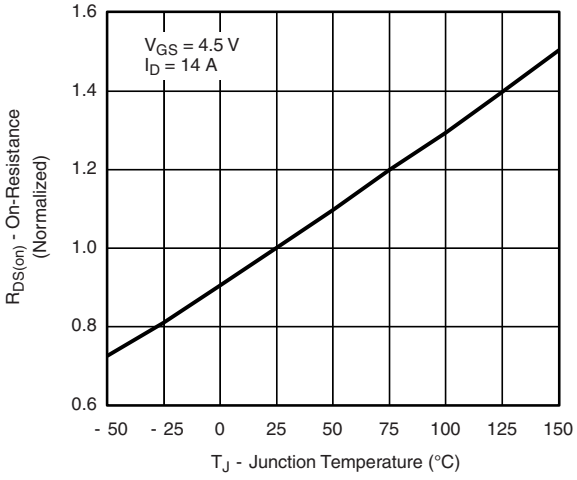
On-Resistance vs. Drain Current



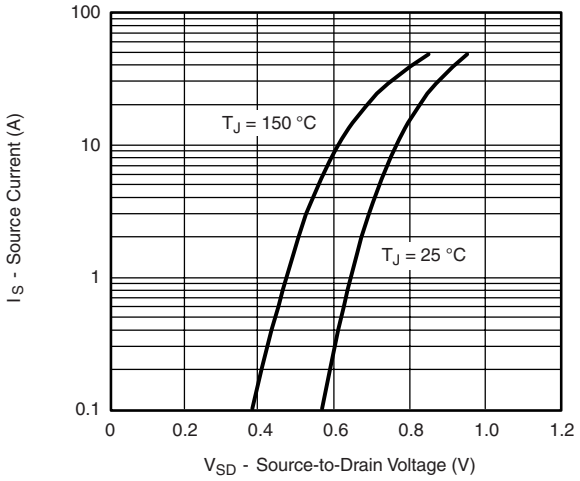
Capacitance



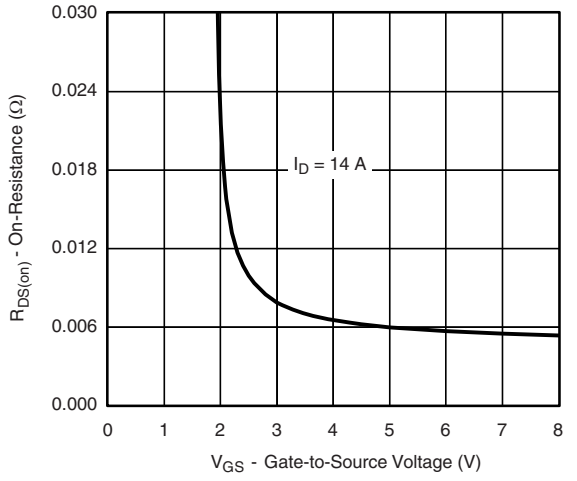
Gate Charge



On-Resistance vs. Junction Temperature

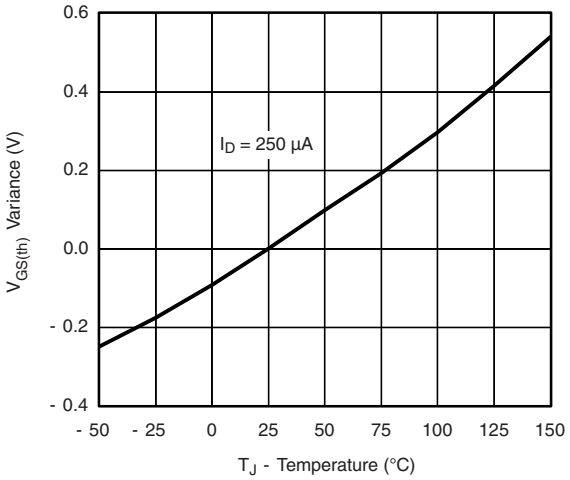


Source-Drain Diode Forward Voltage

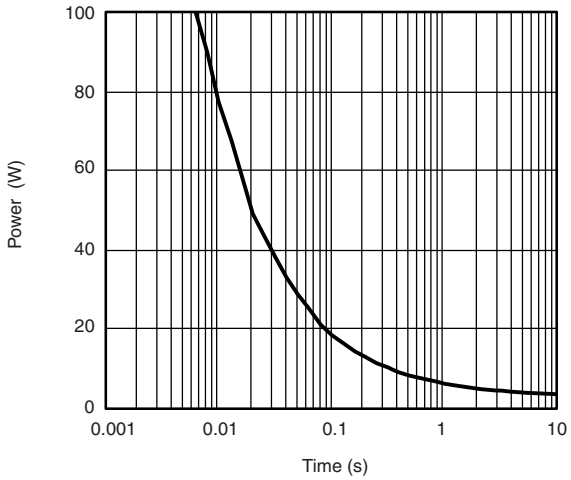


On-Resistance vs. Gate-to-Source Voltage

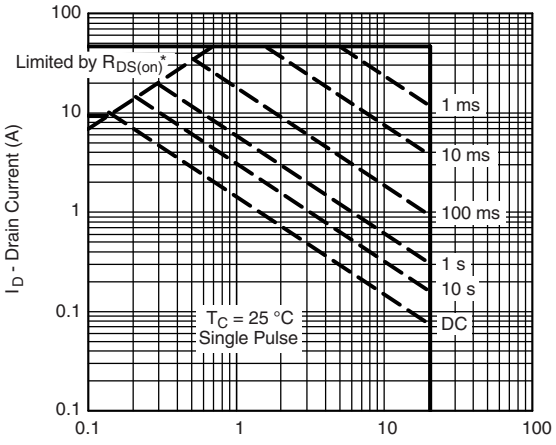
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Threshold Voltage

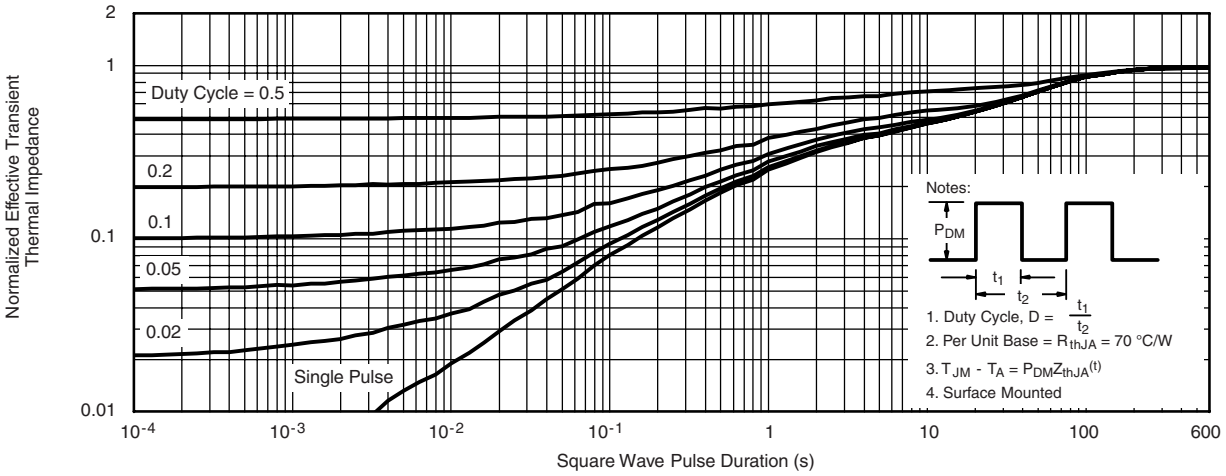


Single Pulse Power, Junction-to-Ambient



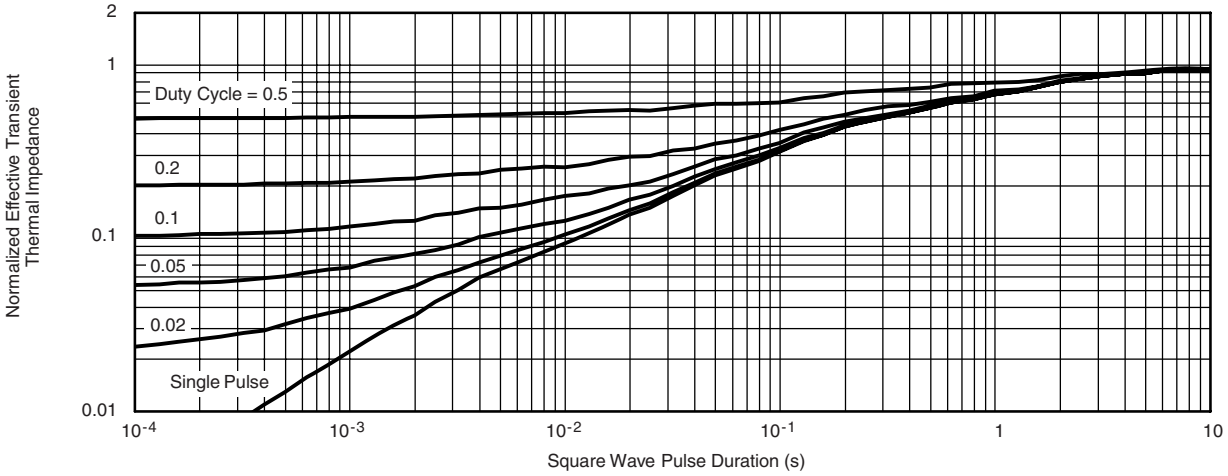
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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